www.emi-tec.de







The FMI-tec

The owner-run, traditional company was founded in 1969 as the Engineering Office Helmut Kahl. In 1986 the EMI-tec Elektronische Materialien GmbH was founded.

Cooperationen with local universities in conjunction with basic development/research and wordwide qualified suppliers, are the basis of competent development and solutions for innovative high-tech products for commercial and military applications. The EMI-tec develops basic materials and components. In addition, the EMI-tec constructs innovative manufacturing equipment & technologies, including machinery, tools and test equipment. The EMI-tec has manufacturing facilities in Budapest (1992) and Shanghai (1999) with experience in small and large series which offers worldwide more than 100 employees a job. Furthermore the EMI-tec is working with global partners in strategic countries and provides the market-leading dispense technology.

The EMI-tec operates several large facilities for serial vacuum evaporation.

The EMI-tec engineers offers rapid prototyping & counseling skills for design and engineering. EMI and also supports

you during the development phase, design and construction of complete production lines for moldings, metallization, dispensing and innovative technologies in accordance with specific customer requirements





Main Branches

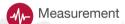
EMI Shielding and Thermal Management







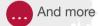










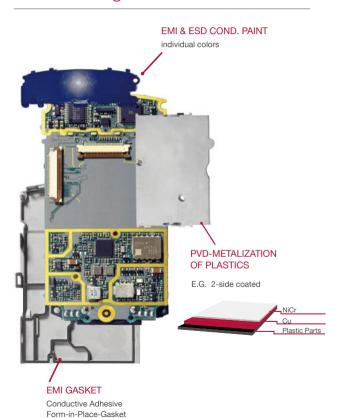


worldwide presence

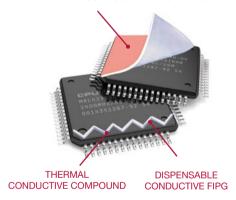


EMI Shielding

Thermal Management



THERMAL CONDUCTIVE PADS AND FOILS





EMI SHIELDING

Product range

Conductive Compound Form-in-Place Gaskets Conductive Adhesive Conductive Coatings Conductive Elastomer Gaskets Transparent EMI Shielding Absorber



CONDUCTIVE COMPOUNDS | FORM-IN-PLACE GASKETS



EMI-tec conductive compounds are particulary long time stable, highly conductive without preload with exceptionally low closing forces, a particulary wide temperature range and outstanding compressionset

The EMI-tec Form-in-Place Gaskets offers an excellent hight-width ratio, which allows particularly small seal widths and hights (from 0,3 mm up to 1,8 mm, or greater)

The Form-in-Place Gasket was developed and approved for high-tech air and space applications, automotive, telecommunication products (base stations, telephones, tetra communication devices and many more)

CONDUCTIVE COMPOUNDS



Micro-Sil Compound

highly conductive

- Very low forces for closing the cabinets super soft material
- Leading room temperature curing 1K materials
- Longtime stable no protection against galvanic corrosion necessary
- The compound can be applied directly on bare metal
- Longtimestable no surface protection against galvanic corrosion nessecary
- Without any preforce
- Easily deformable compounds allow compensation of tolerances between parts with lesser height
- Extra wide temperature range
- Outstanding compression set
- · Reusable seal with high reliability
- Re-sealing of the shelter possible
- Silicone-free available

CC-Micro-Sil Compound

surface conductive

- Form in Place material with a soft non-conductive inner core
 - Covered with electrical high conductive material
- Especially suitable for large gasket dimensions
- · Low costs and low compression forces







CONDUCTIVE ADHESIVE



- High electrical and thermal conductive glue
- From soft elastic to stress resistant bonds
- Soft elastic adhesive cures at room temperature and are excellent for tolerance compensation and vibration damping
- Epoxy conductive glue can cure really slow or very fast too and is particularly relieable strong conductive adhesive



CONDUCTIVE COATINGS



- Conductive Vacuummetallization
- Conductive Paints

CONDUCTIVE COATINGS



EMI-Shield - Conductive Vacuummetalization (PVD)

- Conductive vacuum metallization for EMI
- No electroplating neccessary
- Single-sided, all-sides or partial coatings possible
- Special high screening performance through a unique combination of different metals - Multiple metal layers possible in a single operation
- Several vacuum metallization equipment available
- Typical materials used for the coating
 Cu / CrNi, Cu / Sn, Sn, Cr / Ni, Al, Au, Aq
- The applied layer thicknesses are generally in 1-4 µ

e.g. 2-fold Coating





EX-Shield - Conductive Coatings

- Conductive paint for ESD applications
- High hardness and scratch resistance
- Surface resistance from 10⁵ bis 10⁹ Ohm adjustable
- Resistant to oil and various solvents
- Colour (satin finish) accordingly
 BAL table can be set





CONDUCTIVE ELASTOMER GASKETS

As a result of special customer requirements and decades of research, EMI-tec offers a wide range of high-quality conductive elastomer gaskets. The elastomer gaskets for EMI Shielding have a lower volume resistance and are highly elastic and deformable, while protecting against galvanic corrosion. They are characterized by a large operating temperature range. EMI-tec conductive elastomer gaskets allows an elastic shielding with plates, extruder products, or fittings suitable to your drawing.





FX-Seal Sheets

- Conductive elastomer sheets with low volume resistance
- Large operating range
- Standard or customized up to 1300 mm length
- High elasticity and deformability with extremely low corrosion
- Protection against galvanic corrosion
- In combination with untreated metal long-term stable
- Minimum height tolerances possible particularly flat material

EX-Seal Die-cutted parts

- Die-cutted parts according to your needs
- highly conductive with low volume resistance
- Large operating range
- High elasticity and deformability with extremely low corrosion
- Protection against galvanic corrosion
- In combination with untreated metal long-term stable





CONDUCTIVE ELASTOMER GASKETS



EX-Seal Rings

- Customized rings in small / large cross sections and diameter
- Without burr
- Highly conductive with low volume resistance
- Large operating range
- High elasticity and deformability with extremely low corrosion
- Protection against galvanic corrosion
- In combination with untreated metal long-term stabile

CC-Seal Surface Conductive Gaskets

- Elastomer coated for EMI Shielding like extrusion material or molded parts according to your needs
- Large cross sections, high conductive surface for the skin effect
- Excellent softness for easiest deformation.









Soft-Seal

particulary soft elastomer gasket

- Sealing material for EMI Shielding with low closing forces
- Soft and smooth under compression
- Excellent electrically conductive

FMI-Sil

- Self-adhesive combined gaskets
- Non-conductive environmental gasket with a high conductive inner layer
- Customized shape







TRANSPARENT EMI SHIELDING



EMI-tec EX-Clear is a transparent electrically conductive coated foil for EMI Shielding.

The EMI-tec Ex-Clear Foil is for safe EMI RFI Shielding and ESD Shielding of displays, instruments as well as control surfaces on glass, plastic parts or foil.



ABSORBER



EMI-tec EX-Att Absorber materials are highfrequency absorbing materials.

EMI-tec EX-Att are available as sheets, sections or molded parts, as well as for Form-in-Place Gasket.



TRANSPARENT HEATING

Direct Heat | directly applied heating

The EMI-tec special multi-functional heating concept is especially for displays and sensors

The heating concept can be applied directly on nearly every surface or

shape. Even convex and concave molded polycarbonate parts can be heated. EMI-tec Direct

Heat heating system is very flexible acc. to your needs.



THERMAL MANAGEMENT

EMI-tec thermal management products like thermally conductive films, Gap Filling Pads and products such as LQ-Therm, which is liquid and adapts to your individual form and cures during use.

THERMAL MANAGEMENT



EX-Therm - Gap Filler Pads

- Mechanically flexible, thermally conductive passages for better compensation for tolerances
- compensating thermomechanical tensions as well as an outstanding thermal conductivity
- Available in soft and ultra-soft
- · Particulary, soft and smooth
- · Electrically insulating with high breakdown voltage
- Natural 2-sided adhesive for easy installation
- Self-adhesive type with PSA available
- Non-flammable acc. to UL94 V0
- Without glass fiber reinforcement for consistent hardness over all thickness

LQ-Therm - dispensable thermal management

- Mechanically flexible, thermally conductive passages for better compensation for tolerances
- compensating thermomechanical tensions as well as an outstanding thermal conductivity
- Electrically insulating mono-component based on elastomers.
- Can be applied directly on the heat dissipating components
- Excellent adhesion
- High insulation
- High operation temperature and high elasticity
- · High viscosity, dispensing, and spreadable









FX-Therm Foils – Thermal Conductive Foils

- Electrically insulating thermal conductive foil with high breakdown voltage
- Fiber glass reinforced structure for protection against puncture, tear and shear
- Low surface roughness offers better adaptation to different contact areas
- Requires low contact pressure
- · Soft, smooth, and elastic surface
- Self-adhesive type with PSA
- Non-flammable acc. to UL94 V0





ENVIRONMENTAL SEALING

Form-in-Place Compound / non-conductive

EMI-tec Micro-Sil® MN materials are 1k non-conductive Form-in-Place sealing materials.

EMI-tec Micro-Sil® MN-XXX-BZ1A1 has good oil and water-glycol resistance and an outstanding temperature range. It delivers brilliant performance with softness and very good compression set.



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